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<u>Texas Instruments</u> <u>SN74SSTL16847DGGR</u>

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Datasheet of SN74SSTL16847DGGR - IC INTERFACE BUFF 20BIT 64TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74SSTL16847 20-BIT SSTL_3 INTERFACE BUFFER WITH 3-STATE OUTPUTS

SCBS709A - OCTOBER 1997 - REVISED MAY 1998

- Member of the Texas Instruments Widebus™ Family
- Supports SSTL_3 Signal Inputs and Outputs
- Flow-Through Architecture Optimizes PCB Layout
- Meets SSTL_3 Class I and Class II Specifications
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Packaged in Plastic Thin Shrink Small-Outline Package

description

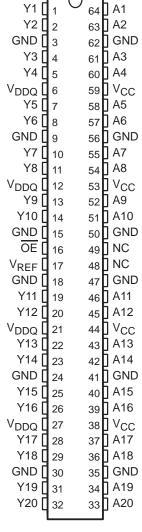
This 20-bit buffer is designed for 3-V to 3.6-V V_{CC} operation and SSTL_3 input levels.

Data flow from A to Y is controlled by the output-enable (\overline{OE}). When \overline{OE} is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74SSTL16847 is characterized for operation from 0°C to 70°C.





NC - No internal connection



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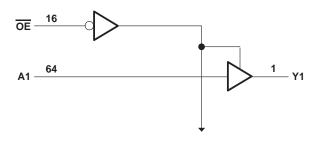
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FUNCTION TABLE

INP	JTS	OUTPUT
OE	Α	Υ
L	Н	Н
L	L	L
Н	Χ	Z

logic diagram (positive logic)



To 19 Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC} or V _{DDQ}	0.5 V to 4.6 V
Input voltage range, V _I (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Notes 1 and 2)	$-0.5 \text{ V to V}_{DDQ} + 0.5 \text{ V}$
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I _{OK} (V _O < 0)	
Continuous output current, I _O (V _O = 0 to V _{DDQ})	±50 mA
Continuous current through each V _{CC} , V _{DDQ} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3):	73°C/W
Storage temperature range, T _{sto}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. This current will flow only when the output is in the high state and $V_O > V_{DDQ}$.
 - 3. The package thermal impedance is calculated in accordance with JESD 51.





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recommended operating conditions (see Note 4)

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		V_{DDQ}		3.6	V
V _{DDQ}	Output supply voltage		3		3.6	V
VREF	Reference voltage (V _{REF} = 0.45 × V _{DDQ})		1.3	1.5	1.7	V
VTT	Termination voltage		V _{REF} -50mV	VREF	V _{REF} +50mV	V
VI	Input voltage		0		VCC	V
VIH	AC high-level input voltage	All inputs	V _{REF} +400mV			V
V _{IL}	AC low-level input voltage	All inputs			V _{REF} -400mV	V
VIH	DC high-level input voltage	All inputs	V _{REF} +200mV			V
VIL	DC low-level input voltage	All inputs			V _{REF} -200mV	V
ІОН	High-level output current				-20	A
loL	Low-level output current		20		mA	
TA	Operating free-air temperature		0	70		°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

F	PARAMETER	TEST CONDITIONS		VCC	MIN	TYP [†]	MAX	UNIT	
VIK		$I_{\parallel} = -18 \text{ mA}$		3 V			-1.2	V	
		I _{OH} = -100 μA I _{OH} = -16 mA		3 V to 3.6 V	V _{CC} -0.	2			
Vон				3 V	2.2			V	
		$I_{OH} = -20 \text{ mA}$		3 V	2.1				
		$I_{OL} = 100 \mu\text{A}$		3 V to 3.6 V			0.2		
VOL		$I_{OL} = 16 \text{ mA}$		3 V			0.5	V	
		$I_{OL} = 20 \text{ mA}$		3 V			0.55		
1.	Data inputs, OE	$V_I = 2.1 \text{ V or } 0.9 \text{ V},$ $V_{REF} =$	= 1.3 V or 1.7 V	3.6 V			±5	μΑ	
lı	VREF	V _{REF} = 1.3 V or 1.7 V		3.0 V			±150	μΑ	
loz		$V_0 = 0.9 \text{ V or } 2.1 \text{ V}$		3.6 V			±10	μΑ	
Icc		$V_I = 2.1 \text{ V or } 0.9 \text{ V}, \qquad I_O = 0$		3.6 V			90	mA	
C.	Control inputs	V _I = 2.1 V or 0.9 V		3.3 V		2		pF	
Ci	A port					2.5		Pi	
Co	Y port	$V_0 = 2.1 \text{ V or } 0.9 \text{ V}$		3.3 V		3.5		pF	

[†] All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.





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switching characteristics over recommended operating free-air temperature range, Class I, $V_{REF} = V_{TT} = V_{DDQ} X$ 0.45 and $C_L = 10 pF$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
^t pd	А	Y	1.5	3	ns
t _{en}	ŌĒ	Y	1.5	4	ns
^t dis	ŌĒ	Y	1.6	4.9	ns

switching characteristics over recommended operating free-air temperature range, Class II, $V_{REF} = V_{TT} = V_{DDQ} \times 0.45$ and $C_L = 30$ pF (unless otherwise noted) (see Figure 1)

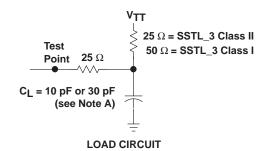
PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
^t pd	А	Υ	1.5	3	ns
t _{en}	OE	Υ	1.5	4.1	ns
^t dis	ŌĒ	Υ	1.5	4.8	ns

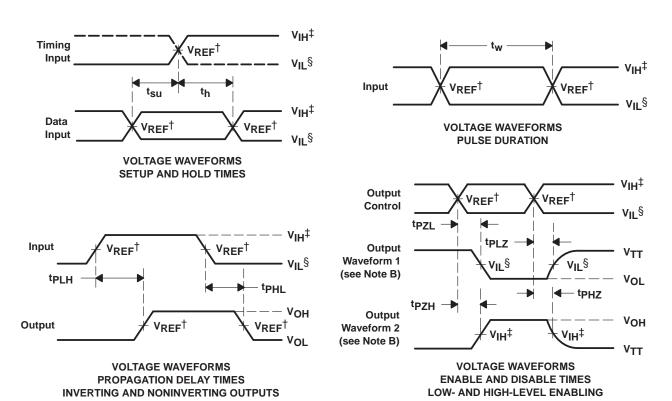


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PARAMETER MEASUREMENT INFORMATION





- $^{\dagger}_{\star}$ V_{REF} = 0.45 V_{DDQ}
- [‡]V_{IH} = V_{REF}+400mV (AC voltage levels)
- § V_{IL} = V_{REF}-400mV (AC voltage levels)
- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 1.25 ns/V, $t_f \leq$ 1.25 ns/V.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. $V_{TT} = V_{REF} = V_{DDQ} \times 0.45$
 - F. tpLz and tpHz are the same as tdis.
 - G. tpzL and tpzH are the same as ten.
 - H. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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